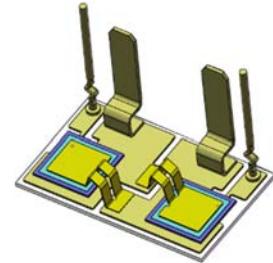


DBC056C/xxKQ-KGxC

Description

- 1) Components adopt vacuum welding to well control void and rated voltage up to 1600V.
- 2) A package of two inverse parallel SCRs.
- 3) Thyristor chips are welding on the ceramic copper clad laminate, products with high electricity ability, excellent heat dissipation ability.



Typical Application

Constant temperature system, CNC machine, remote control system, lighting control, power compensation and so on.

Absolute Maximum Ratings (Packaged into modules, unless otherwise specified, $T_{CASE}=25^{\circ}\text{C}$)

Parameter	Test Conditions	Symbol	Values		Unit
			12	16	
Operating junction temperature range		T_J	-40~+125		°C
Repetitive peak off-state voltage	$T_J=25^{\circ}\text{C}$	V_{DRM}	1200	1600	V
Repetitive peak reverse voltage	$T_J=25^{\circ}\text{C}$	V_{RRM}	1200	1600	V
Non-repetitive peak off-state voltage	$T_J=25^{\circ}\text{C}$	V_{DSM}	1300	1700	V
Non-repetitive peak reverse voltage	$T_J=25^{\circ}\text{C}$	V_{RSM}	1300	1700	V
Average on-state current	$T_c=80^{\circ}\text{C}$	$I_{T(AV)}$	56		A
RMS on-state current	$T_c=80^{\circ}\text{C}$	$I_{T(RMS)}$	90		A
Non-repetitive surge peak on-state current	$t_P=10\text{ms}$	I_{TSM}	1120		A
I^2t value for fusing	$t_P=10\text{ms}$	I^2t	6200		A^2s
Critical rate of rise of on-state current	$I_G=2 \times I_{GT}$	di/dt	150		$\text{A}/\mu\text{s}$

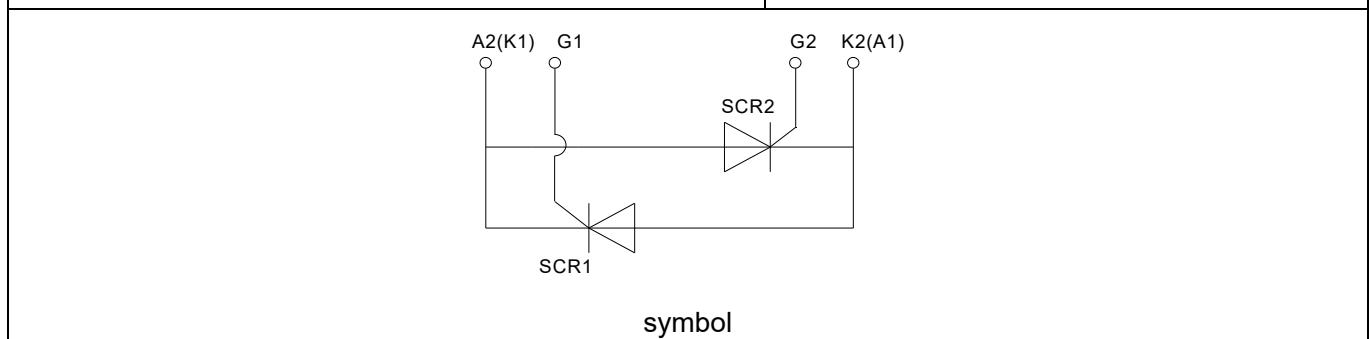
Electrical Characteristics (Packaged into modules, unless otherwise specified, $T_{CASE}=25^{\circ}\text{C}$)

Parameter	Test Conditions	Symbol	Values	Unit
Peak on-state voltage	$I_{TM}=168\text{A}, t_P=380\mu\text{s}$	V_{TM}	≤ 1.8	V
Repetitive peak off-state current	$V_D=V_{DRM}$ $T_c=25^{\circ}\text{C}$ $T_c=125^{\circ}\text{C}$	I_{DRM1} I_{DRM2}	≤ 50 ≤ 10	μA mA

Repetitive peak reverse current	$V_R=V_{RRM}$ $T_c=25^\circ C$ $T_c=125^\circ C$	I_{RRM1} I_{RRM2}	≤ 50 ≤ 10	μA mA
Triggering gate current	$V_D=12V R_L=30\Omega$	I_{GT}	10-80	mA
Latching current	$I_G=1.2 I_{GT}$	I_L	≤ 200	mA
Holding current	$I_T=1A$	I_H	≤ 150	mA
Triggering gate voltage	$V_D=12V R_L=30\Omega$	V_{GT}	≤ 1.5	V
Non triggering gate voltage	$V_D=V_{DRM} T_J=125^\circ C$	V_{GD}	≥ 0.25	V
Critical rate of rise of voltage	$V_D=2/3V_{DRM} T_J=125^\circ C$ Gate Open	dv/dt	≥ 1000	$V/\mu s$

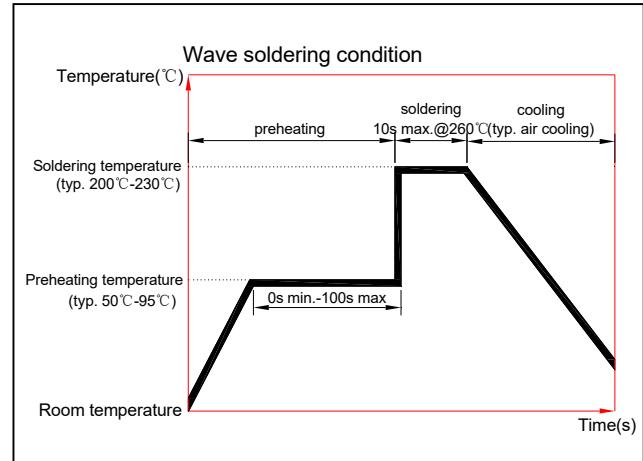
Mechanical Characteristics

Chip size	8.9mm×8.9mm																																																																																																																																								
Module size	29.7mm×18.2mm																																																																																																																																								
Terminal height	19.2mm																																																																																																																																								
Solder composition and melting point of DBC	Solder composition: Pb92.5%Sn5%Ag2.5%; melting point>295°C.																																																																																																																																								
 DBC056C/xxKQ-KGxC	<table border="1"> <thead> <tr> <th rowspan="2">Ref</th> <th colspan="6">Dimensions</th> </tr> <tr> <th colspan="3">Millimeters</th> <th colspan="3">Inches</th> </tr> <tr> <th>Min</th> <th>Typ</th> <th>Max</th> <th>Min</th> <th>Typ</th> <th>Max</th> </tr> </thead> <tbody> <tr> <td>A</td> <td>3.7</td> <td>4.0</td> <td>4.3</td> <td>0.146</td> <td>0.157</td> <td>0.169</td> </tr> <tr> <td>B</td> <td>10.3</td> <td>10.8</td> <td>11.3</td> <td>0.406</td> <td>0.425</td> <td>0.445</td> </tr> <tr> <td>C</td> <td>3.7</td> <td>4.0</td> <td>4.3</td> <td>0.146</td> <td>0.157</td> <td>0.169</td> </tr> <tr> <td>D</td> <td></td> <td>1.0</td> <td></td> <td></td> <td>0.039</td> <td></td> </tr> <tr> <td>E</td> <td></td> <td>10.65</td> <td></td> <td></td> <td>0.419</td> <td></td> </tr> <tr> <td>F</td> <td>0.3</td> <td>0.5</td> <td>0.7</td> <td>0.012</td> <td>0.020</td> <td>0.028</td> </tr> <tr> <td>G</td> <td></td> <td></td> <td>19.2</td> <td></td> <td></td> <td>0.756</td> </tr> <tr> <td>H</td> <td></td> <td></td> <td>19.2</td> <td></td> <td></td> <td>0.756</td> </tr> <tr> <td>I</td> <td>0.4</td> <td>0.9</td> <td>1.4</td> <td>0.016</td> <td>0.035</td> <td>0.055</td> </tr> <tr> <td>J</td> <td>3.9</td> <td>4.4</td> <td>4.9</td> <td>0.154</td> <td>0.173</td> <td>0.193</td> </tr> <tr> <td>K</td> <td></td> <td></td> <td>6.0</td> <td></td> <td></td> <td>0.236</td> </tr> <tr> <td>L</td> <td></td> <td></td> <td>6.2</td> <td></td> <td></td> <td>0.244</td> </tr> <tr> <td>M</td> <td>29.4</td> <td>29.7</td> <td>30</td> <td>1.157</td> <td>1.169</td> <td>1.181</td> </tr> <tr> <td>N</td> <td>17.9</td> <td>18.2</td> <td>18.5</td> <td>0.705</td> <td>0.717</td> <td>0.728</td> </tr> <tr> <td>O</td> <td>1.6</td> <td>2.1</td> <td>2.6</td> <td>0.063</td> <td>0.083</td> <td>0.102</td> </tr> <tr> <td>P</td> <td>25.1</td> <td>25.6</td> <td>26.1</td> <td>0.988</td> <td>1.008</td> <td>1.028</td> </tr> </tbody> </table>						Ref	Dimensions						Millimeters			Inches			Min	Typ	Max	Min	Typ	Max	A	3.7	4.0	4.3	0.146	0.157	0.169	B	10.3	10.8	11.3	0.406	0.425	0.445	C	3.7	4.0	4.3	0.146	0.157	0.169	D		1.0			0.039		E		10.65			0.419		F	0.3	0.5	0.7	0.012	0.020	0.028	G			19.2			0.756	H			19.2			0.756	I	0.4	0.9	1.4	0.016	0.035	0.055	J	3.9	4.4	4.9	0.154	0.173	0.193	K			6.0			0.236	L			6.2			0.244	M	29.4	29.7	30	1.157	1.169	1.181	N	17.9	18.2	18.5	0.705	0.717	0.728	O	1.6	2.1	2.6	0.063	0.083	0.102	P	25.1	25.6	26.1	0.988	1.008	1.028
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Soldering Process Requirements

a. Hand soldering iron welding	
Soldering temperature	$\leq 260^{\circ}\text{C}$
Soldering time	$\leq 10\text{s}$
b. Wave soldering (see figure at right)	
Preheating temperature	$\leq 125^{\circ}\text{C}$
Preheating time	$\leq 100\text{s}$
Soldering temperature	$\leq 260^{\circ}\text{C}$
Soldering time	$\leq 10\text{s}$



Working Conditions

1) No severe mechanical shock as impact and drop off in the process of transportation, storage and working of product.

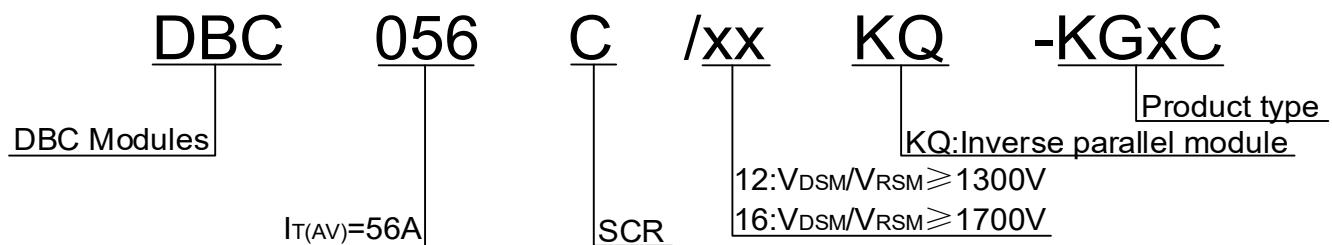
2) Storage conditions

Temperature: $5\text{~}40^{\circ}\text{C}$

Relative humidity: $\leq 45\%$

Storage time: 3 days for the open package; 3 months for the closed package

Ordering Information



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